

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Peter Cuong Dac Ta

Assignee: Sun Microsystems, Inc.

Title: CIRCUIT BOARD RETAINING BRACKETS

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Unit:

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Monterey, CA
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CLEAN COPY OF DESCRIPTION REPLACEMENT PARAGRAPHS

Replace the paragraph extending from Page 2, line 27 to
Page 3, line 1 with:

JK
--In one particular embodiment, the mother board retaining bracket includes a body having a mounting aperture, one or more upper tabs extending perpendicularly from the body, and one or more lower tabs extending perpendicularly from the body. The upper tabs lie in a first plane and the lower tabs lie in a second plane spaced apart from the first plane. The upper tabs, the lower tabs, and the body define a slot, and the edge of the mother board is supported in the slot.--

Replace the paragraph extending from Page 10, line 29 to
Page 11, line 6 with:

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--As shown in FIG. 5, upper tab(s) 310, body 302 and lower tab(s) 312 define a slot 502. Generally, upper tab(s) 310 lie in a first plane P1 and lower tab(s) 312 lie in a second plane P2, spaced apart and parallel to plane P1. The width of slot 502, e.g., see characteristic A8 of FIG. 8 for example, is equal to or slightly greater than the width WMB of mother board 214A. Accordingly, edge 214E of mother board 214A, e.g., a printed circuit board, fits tightly into slot 502 such that an upper, e.g., first, surface 214U of mother board 214A is

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supported by upper tab(s) 310 and a lower, e.g., second, surface 214L of mother board 214A is supported by lower tab(s) 312.--

Replace the paragraph extending from Page 11, line 18 to line 25 with:

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--FIG. 6 is a front plan view of mother board retaining bracket 230A of FIG. 3 in accordance with one embodiment of the present invention. In one embodiment, mother board retaining bracket 230A is hard steel, which has been stamped and bent as those of skill in the art will understand. Illustrative specifications for the various characteristics illustrated in FIG. 6 are set forth below in Table 1.--

Replace the paragraph extending from Page 12, line 1 to line 4 with:

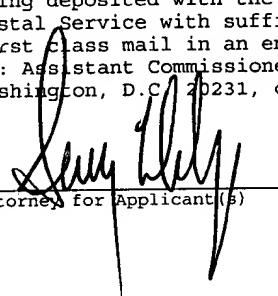
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--FIG. 7 is a side plan view of mother board retaining bracket 230A of FIG. 6. An illustrative specification for the various characteristics illustrated in FIG. 7 is set forth below in Table 2.--

Replace the paragraph extending from Page 12, line 6 to line 9 with:

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--FIG. 8 is another side plan view of mother board retaining bracket 230A of FIG. 6. Illustrative specifications for the various characteristics illustrated in FIG. 8 are set forth below in Table 3.--

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on April 30, 2002.


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April 30, 2002
Date of Signature

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